

PHX18NQ11-VB Datasheet N-Channel 100-V (D-S) MOSFET

PRODUCT	SUMMARY	
V _{(BR)DSS} (V)	r _{DS(on)} (Ω)	I _D (A)
100	0.034 at V _{GS} = 10 V	50 ^a

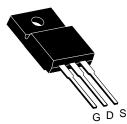
FEATURES

- Trench Power MOSFET
- 175 °C Junction Temperature
- Low Thermal Resistance Package
- 100 % R_g Tested

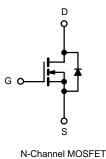
APPLICATIONS

• Isolated DC/DC Converters





TO-220 FULLPAK



ABSOLUTE MAXIMUM RATINGS T_C = 25 °C, unless otherwise noted Parameter Symbol Limit Unit Drain-Source Voltage V_{DS} 100 V ± 20 Gate-Source Voltage V_{GS} T_C = 25 °C 50^a Continuous Drain Current (T_J = 175 °C) I_D T_C = 125 °C 28^a А **Pulsed Drain Current** 120 I_{DM} Avalanche Current I_{AS} 31 L = 0.1 mH61 Single Pulse Avalanche Energy^b E_{AS} mJ T_C = 25 °C 360^c P_D Maximum Power Dissipation^b W $T_A = 25 \ ^{\circ}C^d$ 3.70 T_J, T_{stg} Operating Junction and Storage Temperature Range - 55 to 175 °C

THERMAL RESISTANCE RATINGS				
Parameter		Symbol	Limit	Unit
Junction-to-Ambient	PCB Mount (TO-263) ^d	R _{thJA}	40	°C/W
Junction-to-Case (Drain)		R _{thJC}	0.4	C/VV

Notes:

a. Package limited.

b. Duty cycle \leq 1 %.

c. See SOA curve for voltage derating.

d. When Mounted on 1" square PCB (FR-4 material).

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	-				1	1	
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{DS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	100			V	
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1.5		2.5	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
		$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1		
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$			50	50 µA	
		$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 175 ^{\circ}\text{C}$			250		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	120			А	
		V _{GS} = 10 V, I _D = 30 A		0.034			
Drain-Source On-State Resistance ^a		0.063		Ω			
		V_{GS} = 10 V, I _D = 30 A, T _J = 175 °C		0.084			
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 30 A	25			S	
Dynamic ^b							
Input Capacitance	C _{iss}			5100			
Output Capacitance	C _{oss}	V_{GS} = 0 V, V_{DS} = 25 V, f = 1 MHz		480		pF	
Reverse Transfer Capacitance	C _{rss}			210			
Total Gate Charge ^c	Qg			90	130		
Gate-Source Charge ^c	Q _{gs}	V_{DS} = 100 V, V_{GS} = 10 V, I_{D} = 65 A		23		nC	
Gate-Drain Charge ^c	Q _{gd}			34			
Gate Resistance	Rg		0.5	1.7	3.3	Ω	
Turn-On Delay Time ^c	t _{d(on)}			24	35		
Rise Time ^c	t _r	V_{DD} = 100 V, R _L = 1.5 Ω		220	330	20	
Turn-Off Delay Time ^c	t _{d(off)}	$\rm I_D \cong 65$ A, $\rm V_{GEN}$ = 10 V, $\rm R_g$ = 2.5 Ω		45	70	ns	
Fall Time ^c	t _f			200	300	l.	
Source-Drain Diode Ratings and Cha	aracteristics 7	$\Gamma_{\rm C} = 25 \ ^{\circ}{\rm C}^{\rm b}$					
Continuous Current	ا _S			50		٥	
Pulsed Current	I _{SM}			120		A	
Forward Voltage ^a	V _{SD}	$I_{F} = 65 \text{ A}, \text{ V}_{GS} = 0 \text{ V}$		1.0	1.5	V	
Reverse Recovery Time	t _{rr}			130	200	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 50 A, di/dt = 100 A/μs		8	12	А	
Reverse Recovery Charge	Q _{rr}			0.52	1.2	μC	

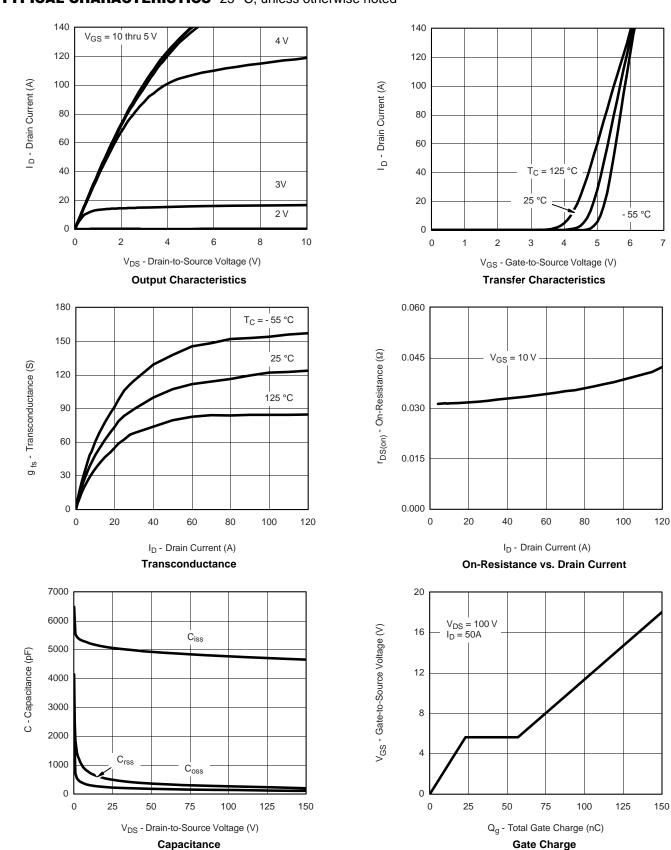
Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing. c. Independent of operating temperature.

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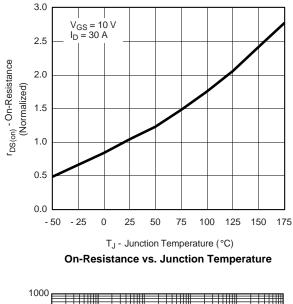


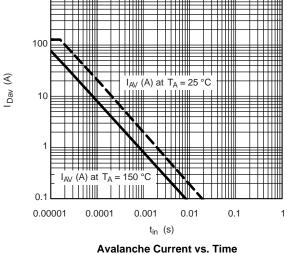


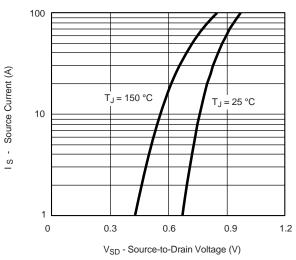
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



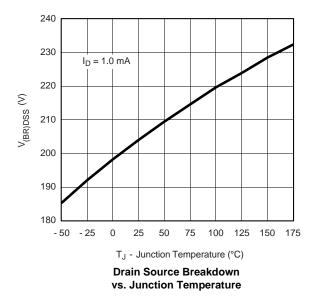
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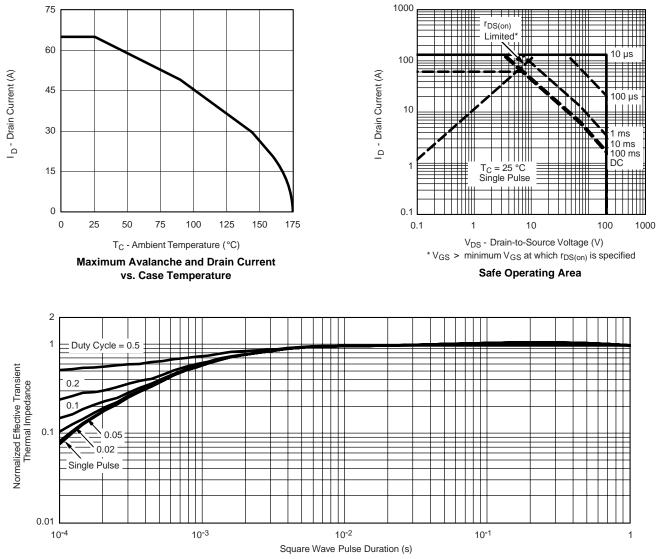
Source-Drain Diode Forward Voltage



PHX18NQ11-VB



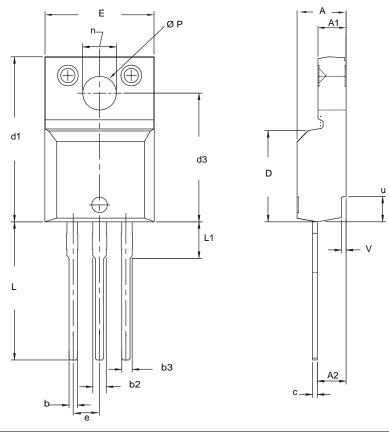
THERMAL RATINGS



Normalized Thermal Transient Impedance, Junction-to-Case



TO-220 FULLPAK (HIGH VOLTAGE)



MIN.	MAX.	MIN.	MAX.	
		IVIIIN.	WAA.	
4.570	4.830	0.180	0.190	
2.570	2.830	0.101	0.111	
2.510	2.850	0.099	0.112	
0.622	0.890	0.024	0.035	
1.229	1.400	0.048	0.055	
1.229	1.400	0.048	0.055	
0.440	0.629	0.017	0.025	
8.650	9.800	0.341	0.386	
15.88	16.120	0.622	0.635	
12.300	12.920	0.484	0.509	
10.360	10.630	0.408	0.419	
2.54 BSC		0.100 BSC		
13.200	13.730	0.520	0.541	
3.100	3.500	0.122	0.138	
6.050	6.150	0.238	0.242	
3.050	3.450	0.120	0.136	
2.400	2.500	0.094	0.098	
0.400	0.500	0.016	0.020	
	2.510 0.622 1.229 1.229 0.440 8.650 15.88 12.300 10.360 2.54 13.200 3.100 6.050 3.050 2.400	2.510 2.850 0.622 0.890 1.229 1.400 1.229 1.400 0.440 0.629 8.650 9.800 15.88 16.120 12.300 12.920 10.360 10.630 2.54 BSC 13.730 3.100 3.500 6.050 6.150 3.050 3.450 2.400 2.500 0.400 0.500	2.510 2.850 0.099 0.622 0.890 0.024 1.229 1.400 0.048 1.229 1.400 0.048 0.440 0.629 0.017 8.650 9.800 0.341 15.88 16.120 0.622 12.300 12.920 0.484 10.360 10.630 0.408 2.54 BSC 0.100 3.100 3.500 0.122 6.050 6.150 0.238 3.050 3.450 0.120 2.400 2.500 0.094 0.400 0.500 0.016	

Notes

1. To be used only for process drawing. 2. These dimensions apply to all TO-220, FULLPAK leadframe versions 3 leads. 3. All critical dimensions should C meet $C_{pk} > 1.33$. 4. All dimensions include burrs and plating thickness. 5. No chipping or package damage.



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